

EQHM53Y Low EMI Oscillator

$5 \times 3.2 \times 1.2$ mm SMD- Specification Group 'Y' 10.0MHz to 160MHz

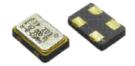
- Provides up to 15dB reduction in system EMI
- 'Drop-in' replacement for standard clocks
- Choice of modulation rate and spread
- Miniature package: 5.0 mm x 3.2 mm x 1.2mm

In electrical systems the principal cause of electromagnetic interference (EMI) is the system clock oscillator. Traditional methods of 'patching-up' systems with too high a level of EMI is to use ferrite beads, filters, ground planes, metal shielding and similar costly methods, However, the most efficient and economic method to reduce EMI is to reduce it at source: replace the system clock ocillator with a low EMI clock oscillator.

Compared with conventional clock oscillators, Spread Spectrum (Dithered) Oscillators can reduce EMI by as much as 15dB. The part is a 'drop-in' replacement for a standard clock oscillator hence there is no requirement to re-design existing PCBs.

APPLICATIONS

- Printers, Multiple Function Printers (MPCs)
- Digital Copiers; PDAs
- Networking: LAN/WAN; Routers
- Storage Systems (CD-ROM, VCD, DVD, HDD)
- Scanners; Modems; Projectors
- Embedded Systems
- Musical Instruments
- Automotive: GPS car navigation systems
- LCD PC Monitors; LSD TVs
- ADSL; PCMCIA
- Still Digital Cameras (SDCs)







Page 1 of 2

DESCRIPTION

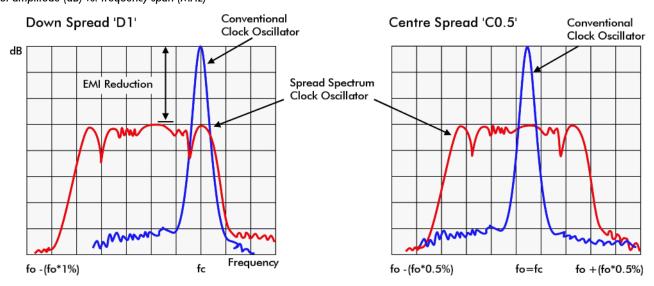
EQHM53 series low EMI oscillators can reduce system EMI by 15dB. The oscillators are a 'drop-in' replacement for standard oscillators. EMI reduction is achieved by the use of Spread Spectrum Technology whereby the mode energy is spread over a wider bandwidth. The modulation carrier frequency, operating in the kHz region, makes the process transparent to the oscillator frequency. There is a choice of modulation rates and spread to suit application requirements.

SPREAD SPECTRUM TECHNOLOGY

Unlike a conventional clock oscillator, in a Spread Spectrum Clock Oscillator the mode energy is spread over a wider bandwidth. This is achieved by the frequency modulation technique. The controlled modulation process may be applied to the 'down' side of the nominal frequency (known as **DOWN SPREAD**,) or spread equally either side of nominal (**CENTRE SPREAD**). Down Spread is preferred if overclocking would cause a problem to the system.

MODULATION TYPES - EXAMPLES

Output amplitude (dB) vs. frequency span (MHz)



Issue 2



EQHM53Y Low EMI Oscillator

5 x 3.2 x1.2mm SMD - Specification Group 'Y' 10MHz to 160MHz

SPECIFICATION

Model No: 3EQHM53 (Group 'Y')
Frequency Range: 10.0MHz to 160.0MHz

Spread Types: See table below

EMI Reduction*: -9dBc min. 100MHz at C0.5**
-15dBc min. 100MHz at C1.5**

With reference to dB level at no modulation.

Modulation Carrier Frequency: 12kHz min, 42kHz max.

Frequency dependent

Call for details

Output Logic: CMOS

Input Voltage: $Vdd = +3.3VDC \pm 5\%$

Frequency Stability***

Commercial (-10 \sim +70 $^{\circ}$ C): \pm 25ppm (Spec. code = 'A') \pm 50ppm (Spec. code = 'B')

 ± 100 ppm (Spec. code = 'C')

Industrial (-40 \sim +85 $^{\circ}$ C):

±25ppm (Spec. code = 'D') ±50ppm (Spec. code = 'E') ±100ppm (Spec. code = 'F')

Output Voltage HIGH '1': 2.4V min., 3.2V typ. (90%Vdd)
Output Voltage LOW '0': 0.5V max., 0.2V typ. (10%Vdd)
Rise/fall Times: 6ns max, (frequency dependent)

Load: 15pF

Start-up Time: 2ms typical, 5ms max.

Storage Temperature: -55° to +125°C

Current Consumption:

10 ~ 49MHz: 10mA typ

50 ~ 125MHz: 27mA typ 44mA max.

Duty Cycle: 50%±5% (CL=15pF, 50%Vdd)

Cyle to Cycle Jitter: ±100ps typ. ±150ps max.

Static Discharge Voltage: >2000V (per MIL STD 833)

Ageing: ±5ppm /year max at Ta=25°C

Packaging: EIA 16mm tape and reel, 1k per

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Pad 1 Option: Output Enable/Disable. Output is high impedance when taken low Output enable time 100ms max.

Notes:

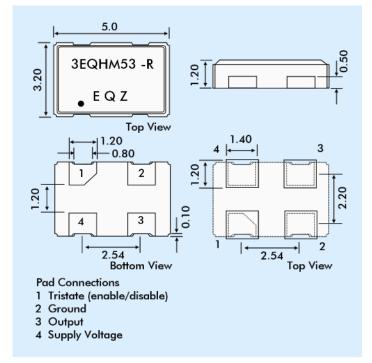
* EMI reduction is applied to the entire frequency spectrum

** dBc: with respect to no modulation. Frequency and total % spread dependant.

*** Frequency Stability parameter excludes modulation.

OUTLINE & DIMENSIONS

Page 2 of 2



ENVIRONMENTAL SPECIFICATION

RoHS Compliance: RoHS compliant and Pb (lead) free

Storage Temperature Range: -55° to +125°C

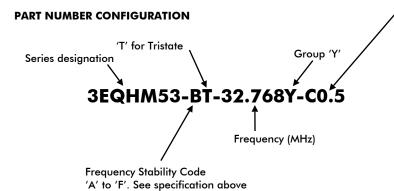
Humidity: 85% RH, 85°C for 48 hours
Hermetic Seal: Leak Rate 2x10-8 ATM-cm³/s max.
Solderability: MIL-STD-2002F method 208E
Reflow: 260° for 10 seconds

Vibration: MIL-STD-202F method 204,

35g 50Hz to 2000Hz Shock: MIL-STD-202F method 213

MIL-STD-202F method 213B, test condition: E, 1000g ½ sine wave

AVAILABILITY OF SPREAD TYPES AND MODULATION RATES



SPREAD TYPES and % MODULATION	
DOWN SPREAD	
D1.0	-1%
D3.0	-3%
CENTRE SPREAD	
C0.5	±0.5%
C1.5	±1.5%